

### **SPECIFICATION SHEET**

SPECIFICATION SHEET NO.	N0623- YR32K76800S001
DATE	June 23, 2021
REVISION	A1
DESCRIPITION	KHz SMD Crystals, L3.2*W1.5*H0.9mm, 2 Pads, CCMM series
	32.76800KHz, +/-20ppm, CL 12.5pF
	Operating Temp. Range -40°C ~+85°C, ESR 70 Kohm Max,
	Reflow Profile Condition 260 °C Max.
	Tape/Reel, 3000pcs/Reel,
	RoHS/RoHS III compliant
CUSTOMER	
CUSTOMER PART NUMBER	
CROSS REF. PART NUMBER	
ORIGINAL PART NUMBER	TGS CCMM 32K768A20-12.5-40-70T LF
PART CODE	YR32K76800S001

### **VENDOR APPROVE**

Issued/Checked/Approved







DATE: June 23, 2021

CUSTOMER APPROVE	
DATE:	



### **KHZ SMD CRYSTALS CCMM SERIES 3215 TYPE**

#### **MAIN FEATURE**

- SMD Package, CCMM Series, L3.2\*W1.5\*H0.9mm, 2 Pads
- Industry standard
- Reflow Profile Condition 260 °C Max.
- Cross more competitors part
- RoHS/RoHS III compliant

#### **APPLICATION**

• Small communications devices and more

# RFQ

Request For Quotation

#### **PART CODE GUIDE**

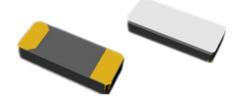
YR	32K76800	S	001
1	2	3	4

- 1) YR: Part family Code for KHz SMD crystal L3.2\*W1.5\*H0.9mm, 2 Pads, CCMM series
- 2) 32K76800: Frequency range code for 32.76800KHz
- 3) S: SMD type, Package Tape/Reel, 3000pcs/Reel
- 4) 001: Specification code for original part No.: TGS CCMM 32K768A20-12.5-40-70T LF

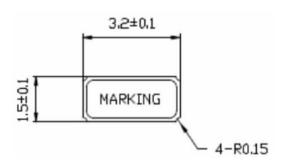
# **KHZ SMD CRYSTALS CCMM SERIES 3215 TYPE**

### **DIMENSION (Unit: mm)**

### Image for reference



#### **CCMM**



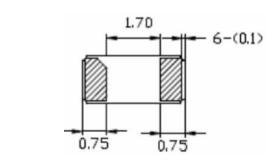
#### Marking

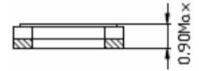
Frequency Range

or

### Marking

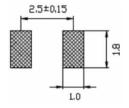
Internal Control Code

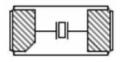


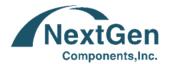




# Land Pattern for reference

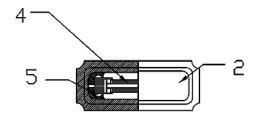


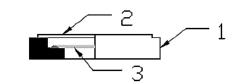




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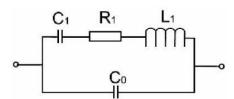
#### PRODUCT STRUCTURE





Item No.	Component Material Name Name	
1	Crystal Case	Ceramic (A1203)
2	Crystal Cover/Lid	KV (Fe/Co/Ni)
3	Crystal SiO2 Chip/Blank	
4	Electrode	Au, Ag
5	Adhesive	Resin, Ag

#### **EQUIVALENT CIRCUIT**



#### **NOTES BEFORE USE**

#### **Ultrasonic Cleaning:**

General cleaning solutions or ultrasonic cleaning method may be used to clean our products. However, under certain circumstances, ultrasonic cleaning machine could generate resonance at the oscillation frequency of our products and thus deteriorate the electrical characteristics in device and even damage the overall structure of device. Therefore, verification test is recommended before cleaning.

#### **Ultrasonic Welding**

Avoid mounting and processing by Ultrasonic welding this method has a possibility of an excessive vibration spreading inside the crystal products and become the cause of characteristic deterioration and not oscillating.

#### **Storage Temperature Description**

Storage Temperature is only for the product itself, the temperature for the packing material is 5~40°C Recommended Conditions for Manual Welding Max. Temperature: 350±10°C, Time: 3 sec Max., Re-solder time: twice Max.



# **KHZ SMD CRYSTALS CCMM SERIES 3215 TYPE**

#### **ELECTRICAL PARAMETERS**

Parameter		Part No. Symbol	Units	Value			Condition
		Symbol		Min.	Typical	Max.	
Original	Manufacturer	TGS		TGS	Crystals		
Holder 1	<b>Туре</b>	ССММ	KHz SM	D Crystal L3.2	2*W1.5*H0.9mm	ı, 2 Pads	
Frequen	cy Range	32K768	KHz		32.76800		
Mode of	f Oscillation	А			AT Fundament	al	
Frequen	cy Tolerance	20	ppm	-20		+20	@25°C
Load Ca	pacitance	-12.5	pF		12.5		
Frequen Coefficie	cy/Temp ent		ppm/°C²	-0.02	-	0.04	
Operation Temperation		-40	°C	-40		+85	
Storage	Temperance		°C	-55		+125	
	ent Series ice (ESR)	-70	ΚΩ	70			
Drive Le	vel		μW	0.5			
Shunt Ca (CO)	apacitance		pF	1.1 2.0			
Dynamic (C1)	Capacitance		fF	4.1			
Turnove	r Temp		°C	+20	+25	+30	
Quality	Factor			60000			
Capacita	nce Ratio			450			
Aging			ppm/year	. ±3		±3	@1 <sup>st</sup> year
Insulatio	ulation Resistance MΩ 500			@100Vbc ± 15Vbc			
	Package	Т		Tape/Reel, 3000pcs/Reel			
	RoHS Status LF RoHS III compliant						
Other	Add Value			N/A 2 letter or digits; Blank: N/A			
	Special Code <mark>*</mark>						

Note: 1) Original Part Number: TGS CCMM 32K768A20-12.5-40-70T LF

2) \* Internal Control Code- 2 letter or digits; Blank: N/A



# KHZ SMD CRYSTALS CCMM SERIES 3215 TYPE

#### **RELIABILITY**

Test Items	Test Method And Conditions	Test Standard
High Temperature High Humidity Storage	Temperature: 60°C ± 2 °C Relative Humidity: 90%~95% RH For Time: 500 ± 12 Hours	A, C, D, G
High Temperature Storage	Temperature: 125°C ± 2°C Time: 1000±12 Hours.	В, С, G
Low Temperature Storage	Temperature: -40°C ± 2°C Time: 500 ± 12 Hours.	A, C, G
Temperature Cycle	The crystal unit shall be subjected to 100 successive change of temperature cycles.  +85+4/-0°C  30±3min  3min. max.	A, C, G
Solderability	The solder pot temperature is 260±5°C , dwell time 2±0.6sec	F
Drop Test	Height: 180 cm; Dropped Cycle: 3 cycles; Drop it on to a concrete board for 6 Directions (X,Y,Z), that should be 1 cycle	В, С
Vibration	Frequency Range: 10Hz ~ 55Hz Amplitude: 1.5mm±15%; Sweep time: 2~3 Minutes, 2 Hours in each direction, total 6 Hours	A, C
Leakage Test	Helium Bombing 5.0 ~5.5 Kgf/cm²; for 2 hours	E



# KHZ SMD CRYSTALS CCMM SERIES 3215 TYPE

### **RELIABILITY**

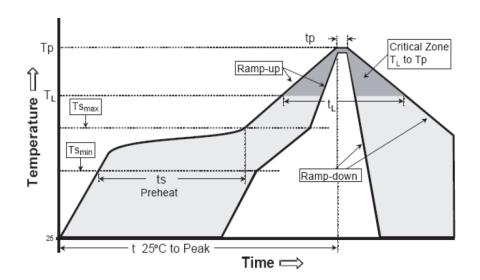
Test Items	Test Method And Conditions	Test Standard
Terminal Strength	Shall be pressurized at a speed of approx. 0.5mm/sec. in the direction indicated by the arrow unit the bending width reaches 3mm and held for 5 sec.  PRESSURE ROD R20  R5  SAMPLE  R5  SAMPLE  R5	B, C
Sticking Tendency	A R0.5 Jig shall be used to apply a 10N dead load in the direction indicated by the arrow to the element and retain it for 10 sec.  JIG R0.5  SAMPLE	B, C
Element Assembly Strength	A RO.5 Jig shall be used to apply a 10N dead load in the direction indicated by the arrow to the element and retain it for 10 sec.	В, С

#### **TEST STANDARD**

Test Standard Symbol	Specification	Value
Α	Frequency Change permitted	ΔF≤10ppm
В	Frequency Change permitted	ΔF≤20ppm
С	Equivalent Series Resistance Change Permitted	ΔCI≤5KΩ or 20%
D	Insulation Resistance	>500 MΩ
E	Leak Rate Less than <1*1E-9 Pa · m³/	
F	A new uniform coating of solder shall cover a Min 95% of the crystal surface	
G	Then 25 ± 2°C over 2 hours before Testing	

### **KHZ SMD CRYSTALS CCMM SERIES 3215 TYPE**

### SUGGESTED REFLOW PROFILE (For Reference No. JEDEC J-STD-020D)

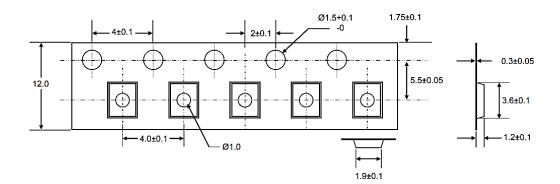


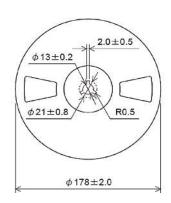
Profile Feature		Pb-Free Assembly
Average Ramp-up Rate (Ts Max to Tp)		3°C/second Max
Preheat	Temperature Min (Ts Min.)	150°C
	Temperature Max (Ts Max.)	200°C
	Time (ts Min. to ts Max.)	60 ~ 120 seconds
Time maintained above	Temperature (TL)	217°C
anove	Time (tL)	60 ~ 150 seconds
Peak/Classification	Temperature (Tp)	260 +/-5°C
Time within 5°C of actual Peak Temperature (tp)		20 ~ 40 seconds
Ramp-down rate		6 °C /Second Max.
Time 25 °C to Peak Temperature		8 minutes Max.
Suggest reflow times		3 Times Max.

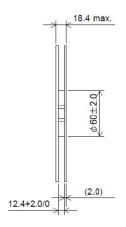
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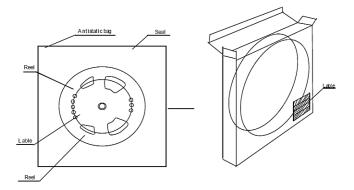
### TAPE/REEL (Unit: mm)

All Devices are packed in accordance with EIA standard RS-481-2 and specifications, 3000pcs/Reel









### **DISCLAIMER**

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